



30V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
N. Ohannal	001/	25mΩ @ V _{GS} = 10V	6.0A
N-Channel	30V	40mΩ @ V _{GS} = 4.5V	4.6A
D. Ohannah	001/	50mΩ @ V _{GS} = -10V	-4.2A
P-Channel	-30V	80mΩ @ V _{GS} = -4.5V	-3.2A

Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

Applications

- DC Motor Control
- DC-AC Inverters

Features

- 2 x N + 2 x P Channels in A SO-8 Package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMHC3025LSDQ</u>)

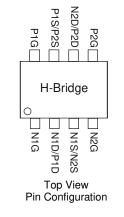
Mechanical Data

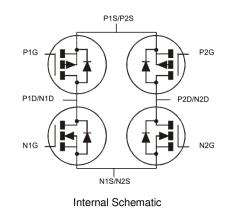
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)



SO-8

Top View





Ordering Information (Note 4)

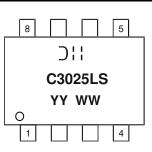
-					
	Part Number	Case	Packaging		
	DMHC3025LSD-13	SO-8	2500/Tape & Reel		
Notes:	s: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.				

No purposely added lead. Fully EU Directive 2002/95/EC (HoHS), 2011/65/EU (HoHS 2) & 2015/863/EU (HoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



)'! = Manufacturer's Marking C3025LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 18 = 2018) WW = Week (01 to 53)



Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	PD	1.5	W		
Thermal Resistance. Junction to Ambient (Note 5)	Steady State	D	83		
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	R _{θJA}	50	°C/W	
Thermal Resistance, Junction to Case		Rejc	14.5		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Maximum Ratings N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit			
Drain-Source Voltage	V _{DSS}	30	V			
Gate-Source Voltage			V _{GSS}	±20	V	
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.0 4.8	А	
Continuous Drain Current (Note 5) V_{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	7.8 6.1	A	
Continuous Drain Current (Noto E) V 4 EV	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	4.6 3.6	А	
Continuous Drain Current (Note 5) V_{GS} = 4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.1 4.8	А	
Maximum Continuous Body Diode Forward Current (Note 5)			Is	2.5	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	60	А	

Maximum Ratings P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage		V _{DSS}	30	V	
Gate-Source Voltage			V _{GSS}	±20	V
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.2 -3.3	А
Continuous Drain Current (Note 5) $V_{GS} = -10V$	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-5.4 -4.3	А
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-3.2 -2.5	А
Continuous Drain Current (Note 5) V _{GS} = -4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-4.3 -3.3	А
Maximum Continuous Body Diode Forward Current (Note 5)			IS	-2.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			IDM	-30	А

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)	.		- 71-			
Drain-Source Breakdown Voltage	BV _{DSS}	30	_		V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_		±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(TH)}	1		2	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance		_	19	25	mΩ	$V_{GS} = 10V, I_D = 5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	26	40	11122	$V_{GS} = 4.5V, I_D = 4A$
Forward Transfer Admittance	Y _{fs}	_	4	_	S	$V_{DS} = 5V, I_D = 5A$
Diode Forward Voltage	V _{SD}	—	0.70	1.2	V	V _{GS} = 0V, I _S = 1.7A
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C _{iss}	_	590	_		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz
Output Capacitance	Coss	_	122	_	pF	
Reverse Transfer Capacitance	C _{rss}	—	58	_		
Gate Resistance	Rg	_	1.5		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.4	_		
Total Gate Charge (V _{GS} = 10V)	Qg	_	11.7	_	nC	
Gate-Source Charge	Qgs	_	1.8		nc	$V_{DS} = 15V, I_D = 7.8A$
Gate-Drain Charge	Q _{gd}	_	2.1	_		
Turn-On Delay Time	t _{D(ON)}	—	11.2	—		
Turn-On Rise Time	t _R	_	15	_		$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(OFF)}		17.5	_	ns	$R_L = 2.4\Omega, R_G = 1\Omega$
Turn-Off Fall Time	tF		8.7			
Reverse Recovery Time	t _{RR}	_	18.3	—	ns	
Reverse Recovery Charge	Q _{RR}	—	12	—	nC	I _F = 12A, di/dt = 500A/μs

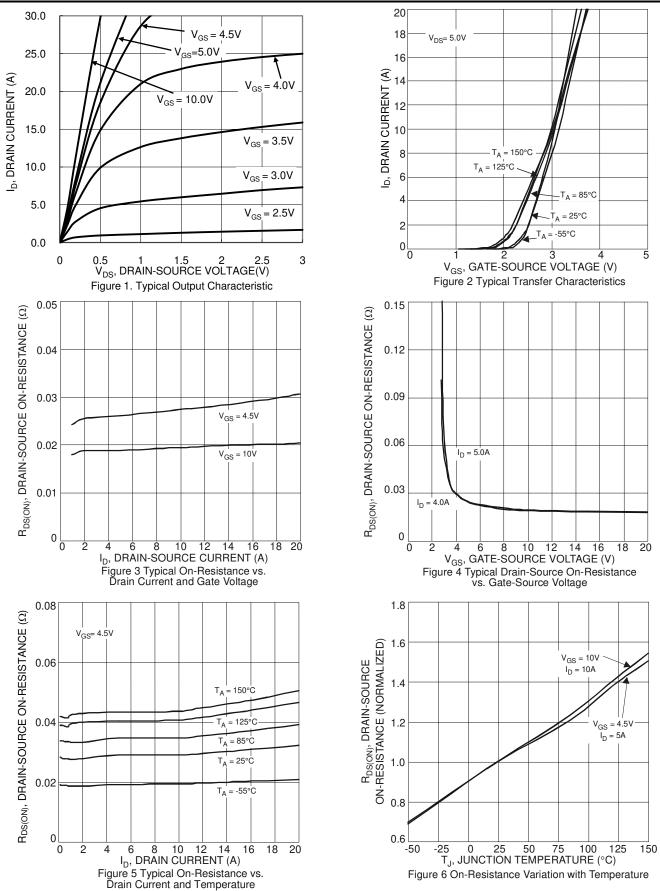
Electrical Characteristics P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Symbol	Min	Тур	Max	Unit	Test Condition
BV _{DSS}	-30			V	$V_{GS} = 0V, I_D = -250\mu A$
IDSS	Ι		-0.5	μA	$V_{DS} = -30V, V_{GS} = 0V$
I _{GSS}	Ι	_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
V _{GS(TH)}	-1	_	-2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
	—	43	50	0	V _{GS} = -10V, I _D = -5A
RDS(ON)	_	68	80	mΩ	V _{GS} = -4.5V, I _D = -4A
Y _{fs}	—	3.5	_	S	$V_{DS} = -5V, I_D = -5A$
V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.7A$
Ciss	—	631	—	pF	
Coss	_	137	_	pF	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz
	_	70	_	pF	
Rg	_	10.8	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Qq	_	5.5	_	nC	
Qq	_	11.4	_	nC	
Q _{gs}	_	1.8	_	nC	$V_{DS} = -15V, I_D = -6A$
Q _{qd}	—	2.4	—	nC	
	_	7.5	_	ns	
t _R	_	4.9	_	ns	V _{DD} = -15V, V _{GS} = -10V,
t _{D(OFF)}	_	28.2	_	ns	$R_{G} = 6\Omega, I_{D} = -1A$
tF	_	13.5	_	ns	1
t _{RR}	_	15.1	—	ns	
	_	15.3	_	nC	I _F = -12A, di/dt = 500A/μs
	BV _{DSS} IDSS IGSS VGS(TH) RDS(ON) Yfs VSD Ciss Coss Crss Rg Qg Qg Qgd tD(ON) tR tD(OFF) tF	BV _{DSS} -30 I _{DSS} I _{GSS} I _{GSS} V _{GS(TH)} -1 R _{DS(ON)} IY _{fs} V _{SD} C _{iss} C _{oss} C _{gg} Q _g Q _g Q _{gd} Q _{gd} t _{D(ON)} t _R t _{RR} t _{RR}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Notes: 6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.

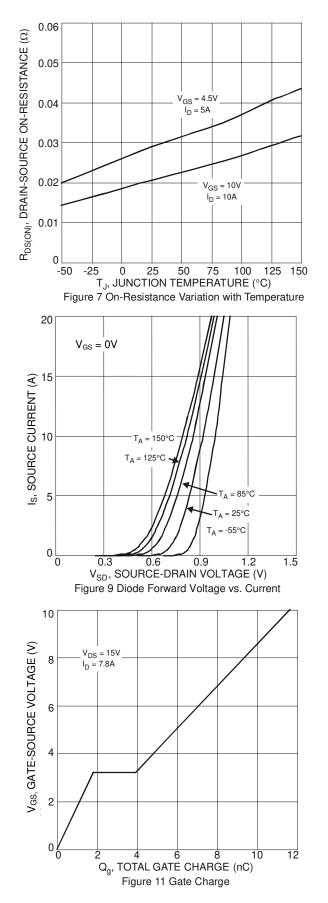


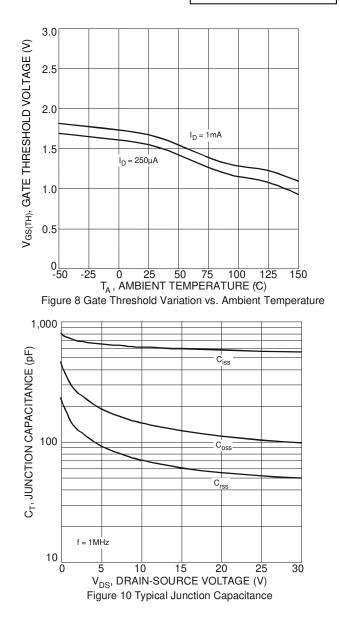
Typical Characteristics - N-CHANNEL



DMHC3025LSD Document number: DS35821 Rev. 5 - 2

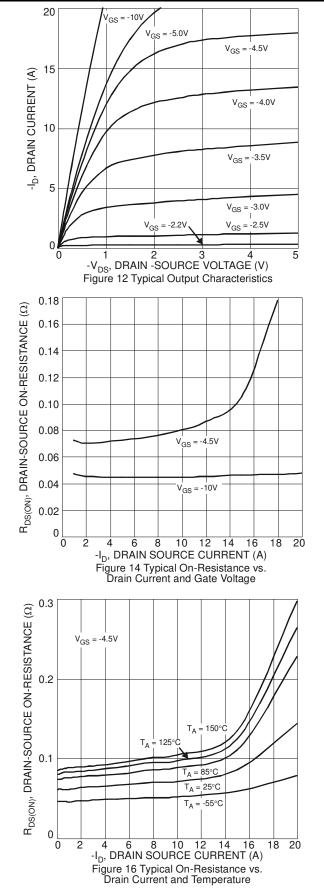


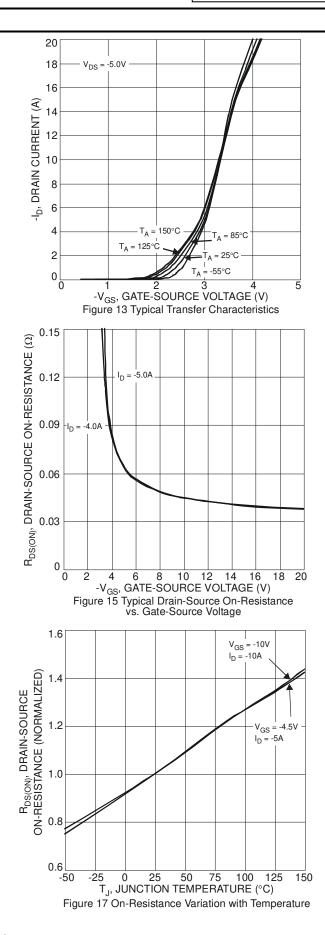




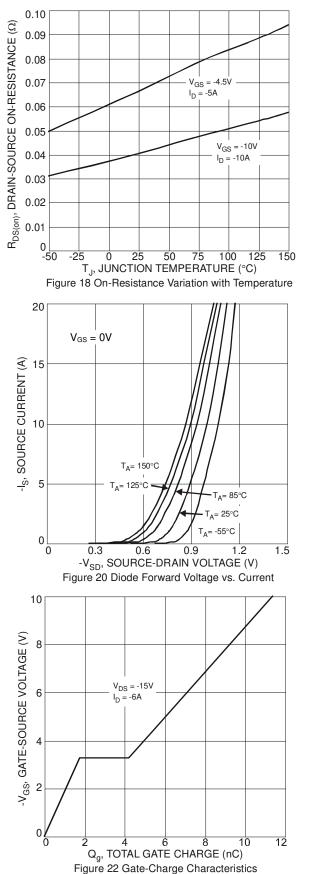


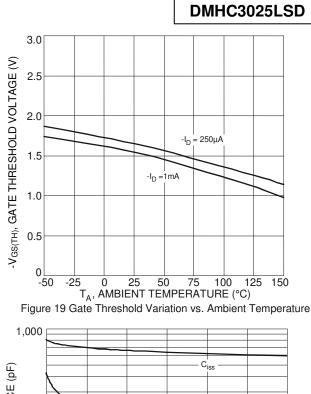
Typical Characteristics - P-CHANNEL

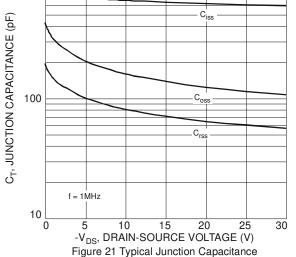








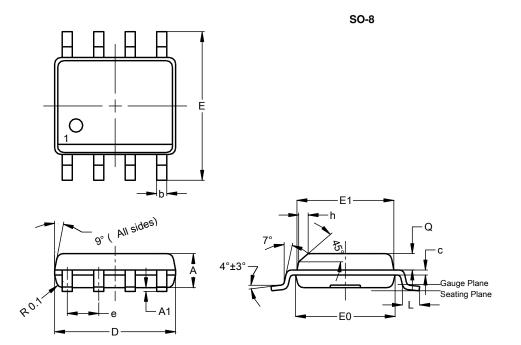






Package Outline Dimensions

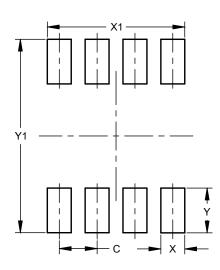
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SO-8						
Dim	Min	Max	Тур				
Α	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
С	0.15	0.25	0.20				
D	4.85	4.95	4.90				
Е	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
е	-		1.27				
h	-		0.35				
L	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All	Dimens	sions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50

SO-8



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